

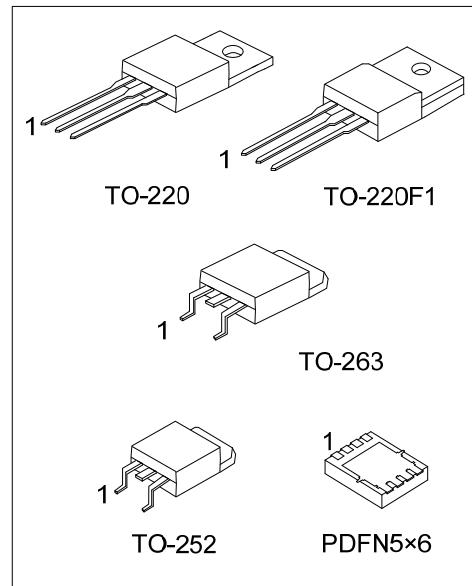
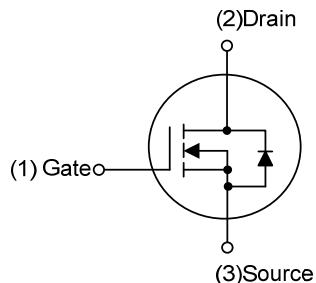
USG135N10H**POWER MOSFET****135A, 100V N-CHANNEL
POWER MOSFET****■ DESCRIPTION**

The UTC **USG135N10H** is a N-channel Power MOSFET, it uses UTC's advanced technology to provide the customers with low $R_{DS(ON)}$ characteristic by high cell density trench technology.

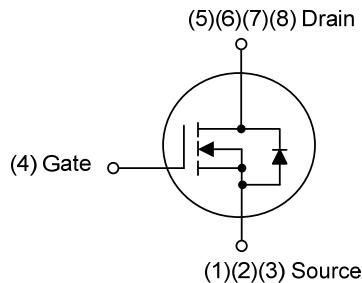
The UTC **USG135N10H** is suitable for high efficiency synchronous rectification in SMPS, UPS, hard switched and high frequency circuits.

■ FEATURES

- * $R_{DS(ON)} \leq 5.5 \text{ m}\Omega$ @ $V_{GS}=10\text{V}$, $I_D=30\text{A}$
- * High Switching Speed

**■ SYMBOL**

TO-220/TO-220F1/TO-263



PDFN5x6

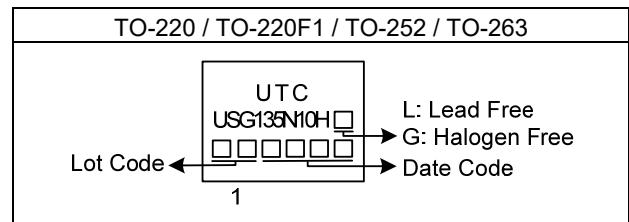
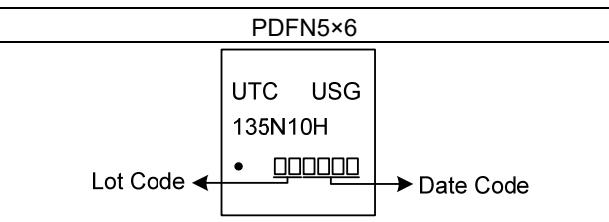
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
USG135N10HL-TA3-T	USG135N10HG-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
USG135N10HL-TF1-T	USG135N10HG-TF1-T	TO-220F1	G	D	S	-	-	-	-	-	Tube
USG135N10HL-TN3-R	USG135N10HG-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
USG135N10HL-TQ2-T	USG135N10HG-TQ2-T	TO-263	G	D	S	-	-	-	-	-	Tube
USG135N10HL-TQ2-R	USG135N10HG-TQ2-R	TO-263	G	D	S	-	-	-	-	-	Tape Reel
USG135N10HL-P5060-R	USG135N10HG-P5060-R	PDFN5x6	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

 (1)Packing Type (2)Package Type (3)Green Package	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TN3: TO-252 TQ2: TO-263, P5060: PDFN5x6 (3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING

TO-220 / TO-220F1 / TO-252 / TO-263	PDFN5×6
 <p>L: Lead Free G: Halogen Free</p> <p>Lot Code ← Date Code</p> <p>1</p>	 <p>Lot Code ← Date Code</p>

■ ABSOLUTE MAXIMUM RATING ($T_c=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	100	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	Continuous	I_D	135	A
	Pulsed (Note 2)	I_{DM}	270	A
Single Pulsed Avalanche Energy (Note 3)		E_{AS}	110	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.9	V/ns
Power Dissipation	TO-220/TO-263	P_D	142	W
	TO-220F1		45	W
	TO-252		71	W
	PDFN5x6		85	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature Range		T_{STG}	-20 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.
 Absolute maximum ratings are stress ratings only and functional device operation is not implied.
 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
 3. $L = 0.1\text{mH}$, $I_{AS} = 47\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$
 4. $I_{SD} \leq 30\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F1	θ_{JA}	62.5	$^\circ\text{C/W}$
	TO-263		110	$^\circ\text{C/W}$
	TO-252		65 (Note)	$^\circ\text{C/W}$
	PDFN5x6		0.88	$^\circ\text{C/W}$
Junction to Case	TO-220/TO-263	θ_{JC}	2.77	$^\circ\text{C/W}$
	TO-220F1		1.76 (Note)	$^\circ\text{C/W}$
	TO-252		1.47 (Note)	$^\circ\text{C/W}$
	PDFN5x6			

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

USG135N10H

Power MOSFET

■ ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, unless otherwise specified)

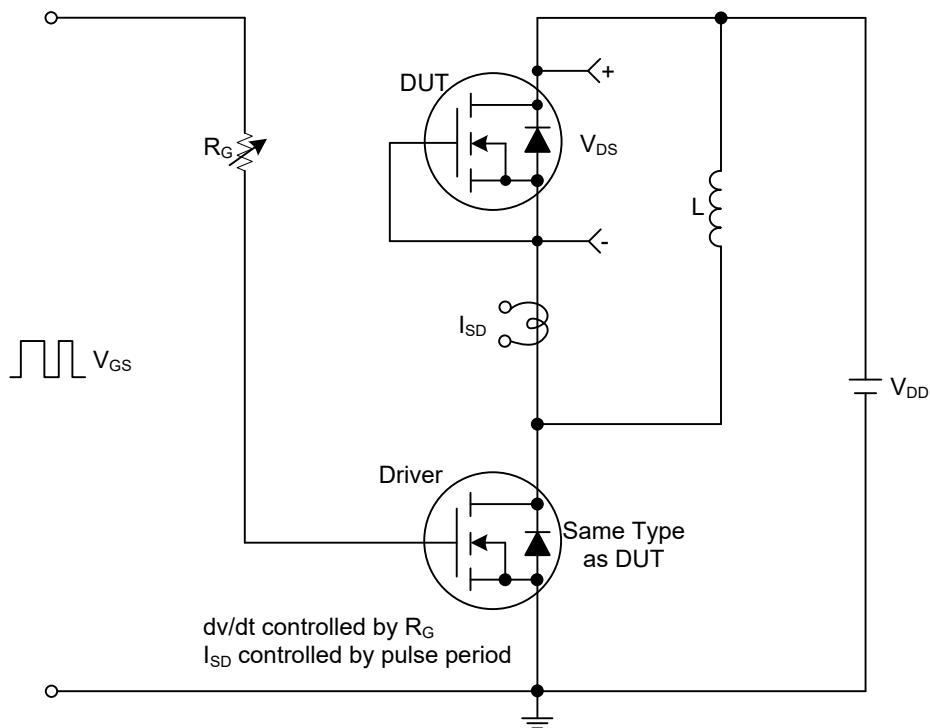
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu\text{A}, V_{\text{GS}}=0\text{V}$	100			V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}$		10		μA
Gate-Source Leakage Current	Forward	$V_{\text{GS}}=+20\text{V}, V_{\text{DS}}=0\text{V}$			+100	nA
	Reverse	$V_{\text{GS}}=-20\text{V}, V_{\text{DS}}=0\text{V}$			-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{\text{GS}(\text{TH})}$	$V_{\text{DS}}=V_{\text{GS}}, I_D=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_D=30\text{A}$			5.5	$\text{m}\Omega$
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=25\text{V}, f=1.0\text{MHz}$		4245		pF
Output Capacitance	C_{OSS}			2171		pF
Reverse Transfer Capacitance	C_{RSS}			186		pF
SWITCHING PARAMETERS						
Total Gate Charge (Note 1)	Q_G	$V_{\text{DS}}=80\text{V}, V_{\text{GS}}=10\text{V}, I_D=135\text{A}, I_G=1\text{mA}$ (Note 1, 2)		95		nC
Gate to Source Charge	Q_{GS}			24		nC
Gate to Drain Charge	Q_{GD}			33		nC
Turn-on Delay Time (Note 1)	$t_{\text{D(ON)}}$	$V_{\text{DD}}=50\text{V}, V_{\text{GS}}=10\text{V}, I_D=135\text{A}, R_G=3.3\Omega$ (Note 1, 2)		18		ns
Rise Time	t_R			22		ns
Turn-off Delay Time	$t_{\text{D(OFF)}}$			49		ns
Fall-Time	t_F			24		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I_S				135	A
Maximum Body-Diode Pulsed Current	I_{SM}				270	A
Drain-Source Diode Forward Voltage (Note 1)	V_{SD}	$I_S=135\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
Reverse Recovery Time (Note 1)	t_{rr}	$I_S=30\text{A}, V_{\text{GS}}=0\text{V}, dI_F/dt = 100\text{A}/\mu\text{s}$		64		nS
Reverse Recovery Charge	Q_{rr}			123		nC

Notes: 1. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

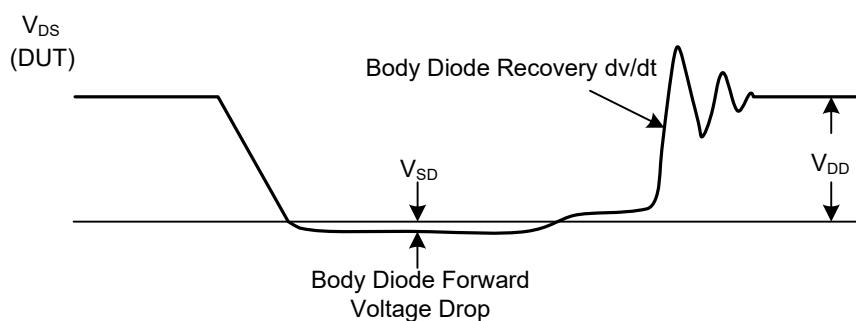
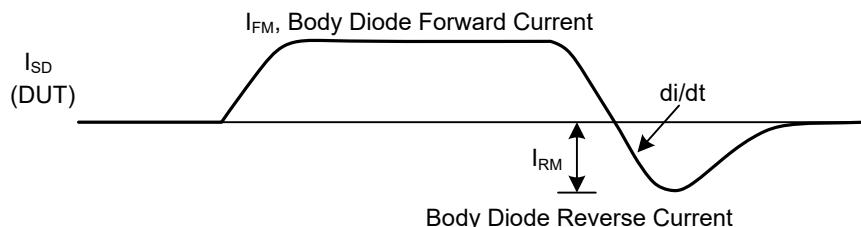
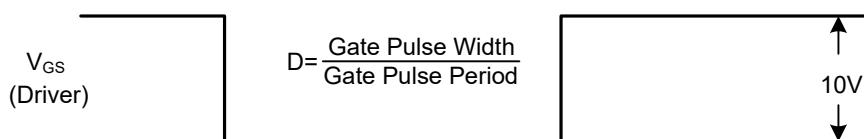
2. Essentially independent of operating ambient temperature.



■ TEST CIRCUITS AND WAVEFORMS



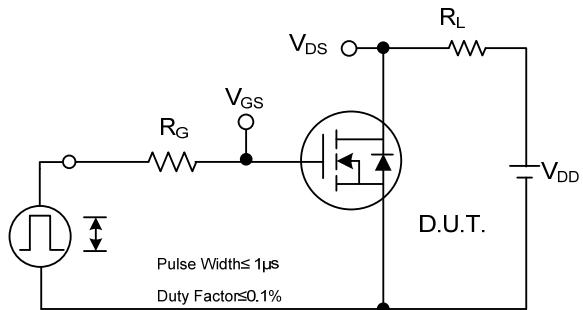
Peak Diode Recovery dV/dt Test Circuit



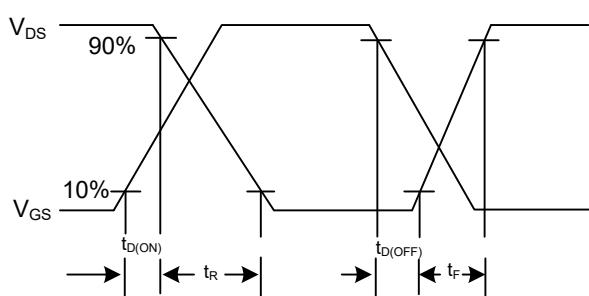
Peak Diode Recovery dV/dt Test Circuit and Waveforms

Peak Diode Recovery dV/dt Waveforms

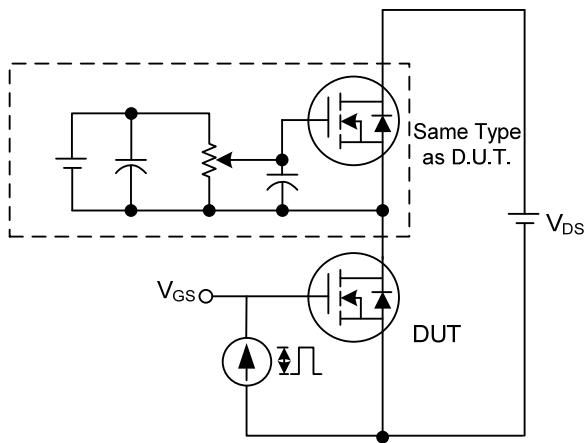
■ TEST CIRCUITS AND WAVEFORMS



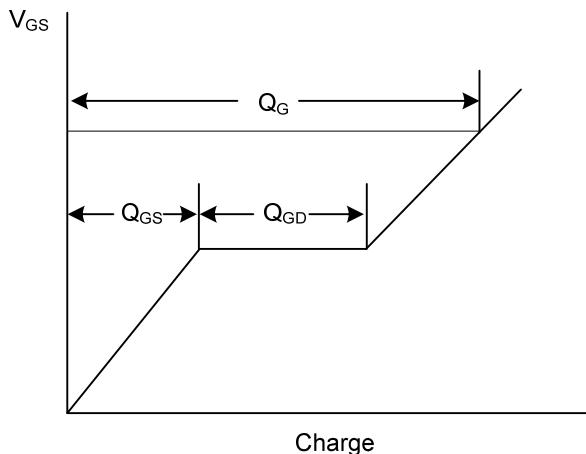
Switching Test Circuit



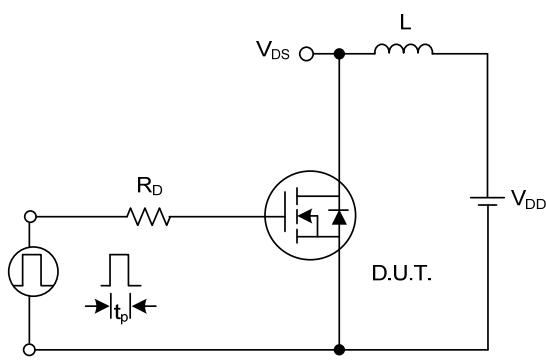
Switching Waveforms



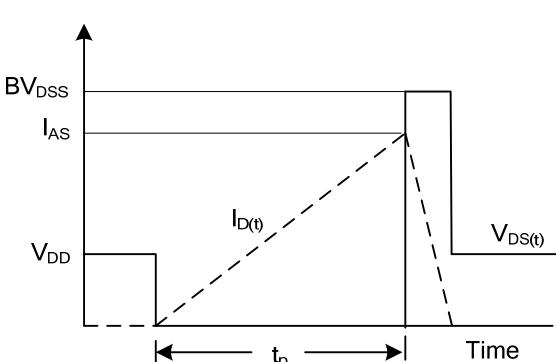
Gate Charge Test Circuit



Gate Charge Waveform

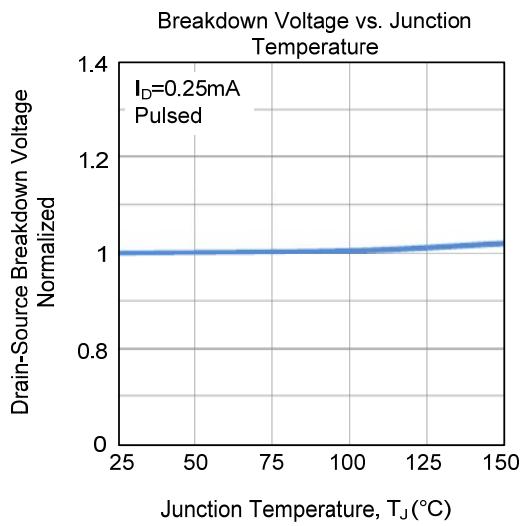
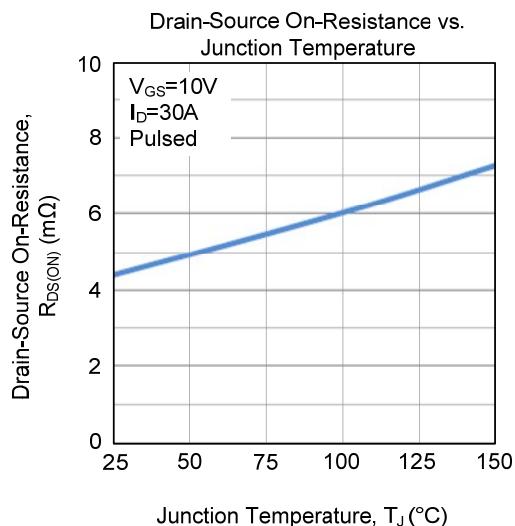
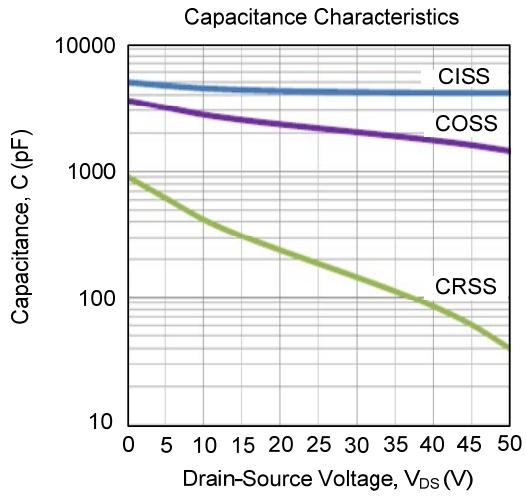
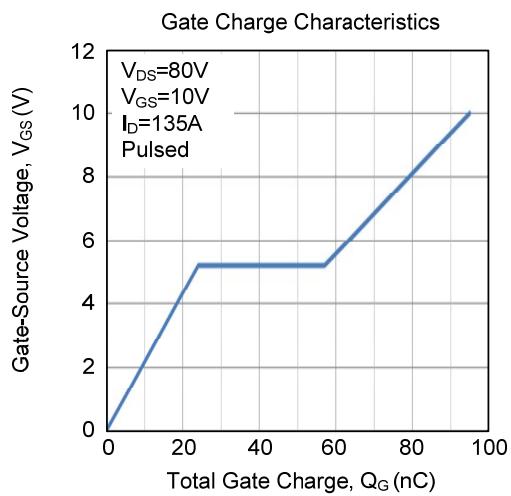
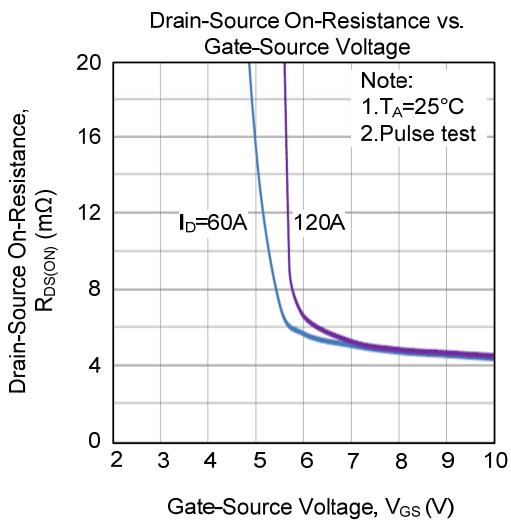
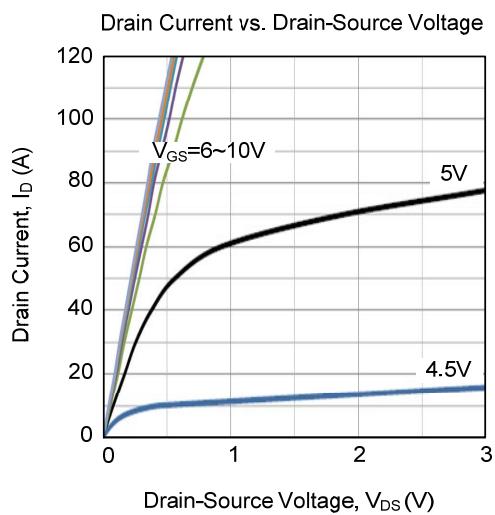


Unclamped Inductive Switching Test Circuit

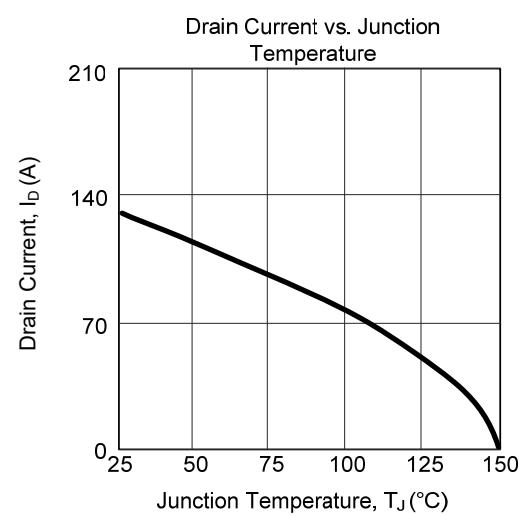
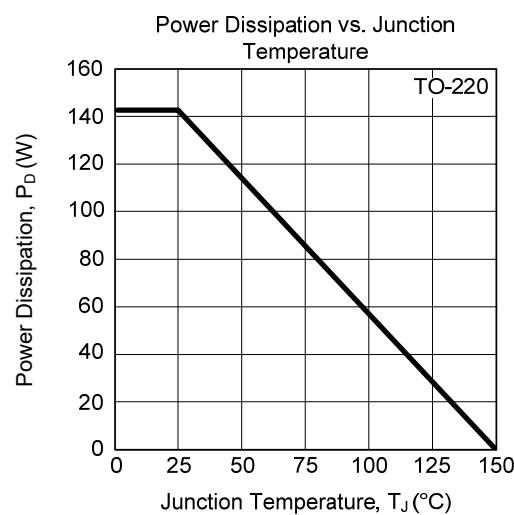
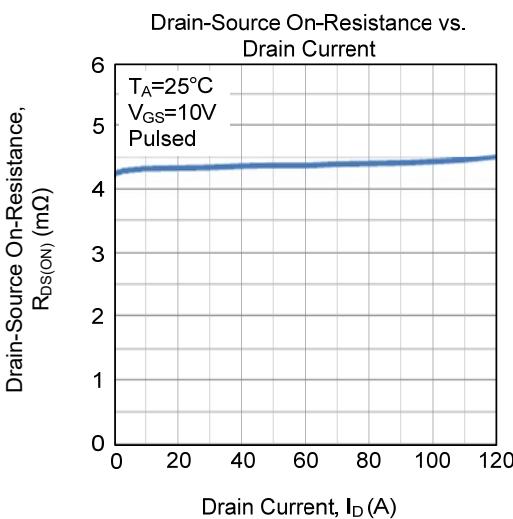
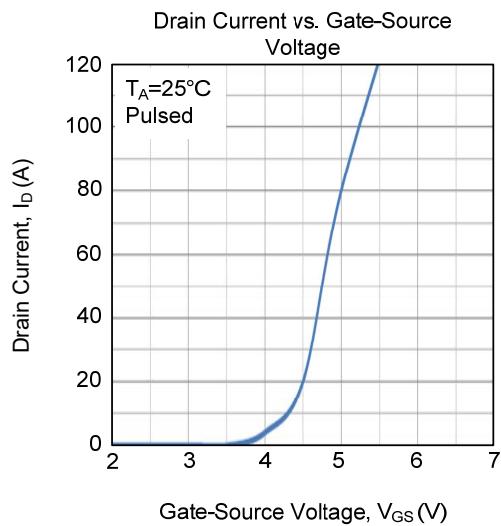
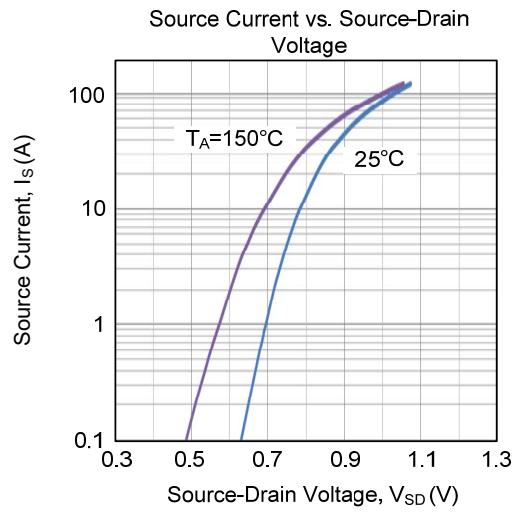
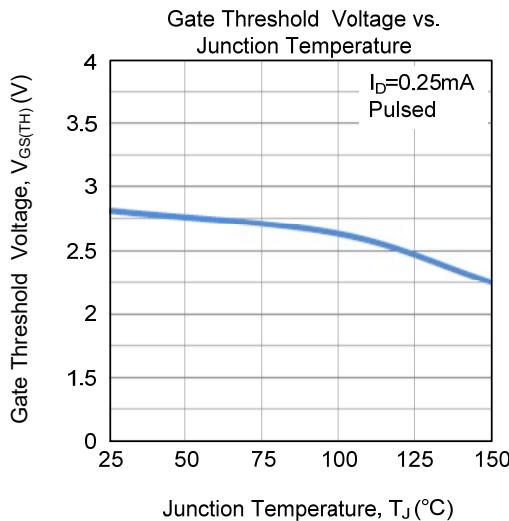


Unclamped Inductive Switching Waveforms

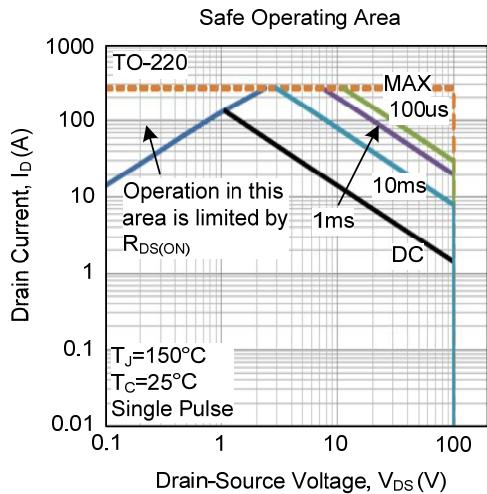
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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